

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s):

Sung Soon Park, Sang Jae Jang, Choon Heung Lee,

Seon Goo Lee, Eun Sook Sohn, Sung Su Park

Assignee:

Amkor Technology, Inc.

Title:

SEMICONDUCTOR PACKAGE STRUCTURE REDUCING WARPAGE

AND MANUFACTURING METHOD THEREOF

Serial No.:

10/672,886

Filed:

September 26, 2003

Examiner:

Tuan H. Nguyen

Group Art Unit:

2813

Docket No.:

GK0017

Chandler, AZ

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

REVOCATION AND SUBSTITUTION OF POWER OF ATTORNEY UNDER 37 C.F.R. §1.36

Sir:

Pursuant to 37 C.F.R. §1.36, Amkor Technology, Inc., the record owner of the above-identified patent application, revokes all previous powers of attorney and hereby appoints the following attorneys and/or agents assigned to the below Customer Number to prosecute this application and transact all business in the U.S. Patent and Trademark Office connected therewith:

Customer Number 23513

Please direct all correspondence and telephone calls concerning this application to:

> Serge J. Hodgson GUNNISON, MCKAY & HODGSON, L.L.P.

1900 Garden Road, Suite 220

Monterey, CA 93940

Telephone: (831) 655-0880

Facsimile: (831) 655-0888.

SERIAL NO. 10/672,886

The undersigned representative of the above-identified assignee certifies that the above-identified assignee is the assignee of the entire right, title and interest in the above-identified patent application by virtue of a chain of title from the inventor(s) of the above-identified patent application to the above-identified assignee.

An Assignment from the <u>inventor(s)</u> of the patent application to <u>Amkor Technology</u>, <u>Inc.</u> was recorded in the U.S. Patent and Trademark Office at Reel/Frame 014561/0233.

The undersigned (whose title is supplied below) is empowered to sign this certificate on behalf of the above-identified assignee.

Signature:

Date

10/21/04

Name:

Paul W. Davis

Title:

Vice President of Intellectual Property Law

Amkor Technology, Inc.



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Monterey, CA October 28, 2004

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REQUEST FOR CHANGE OF ATTORNEY DOCKET NUMBER

Dear Sir:

Please change the Attorney Docket Number in the above application from "AMK-BK-00001" to "GK0017". Please use Attorney Docket Number "GK0017" in all future correspondence with Applicant's attorney.

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Commissioner for Patents, P.Q. Box 1450, Alexandria, VA 22313-1450, on October

28, 2004.

Attorney or Applicant(s)

October 28, 2004

Date of Signature

Respect fully submitted,

Serge J. Hodgson

Attorney for Applicant (s)

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